

GaAs-IR-Lumineszenzdiode mit 3/4 Linse (950nm)

GaAs Infrared Emitter with 3/4 lens (950nm)

Lead (Pb) Free Product - RoHS Compliant

SFH 4113



Wesentliche Merkmale

- Wellenlänge der Strahlung 950 nm
- Hohe Strahlstärke
- Geringe Außenabmessungen

Anwendungen

- Bandende Erkennung (z.B. Videorecorder)
- Datenübertragung
- Positionsüberwachung
- Barcode-Leser
- „Messen/Steuern/Regeln“
- Münzzähler

Features

- Peak wavelength of 950 nm
- High radiant intensity
- Small outline dimensions

Applications

- Tape end detection (VCR e.g.)
- Data transmission
- Position sensing
- Barcode reader
- For control and drive circuits
- Coin counters

Typ Type	Bestellnummer Ordering Code	Ee ¹⁾ [mW/cm ²] at d ²⁾ =6mm, If=4mA
SFH 4113	Q62702P5299	0.25 - 1.25

¹⁾ Auf einem Detektor erzeugte Bestrahlungsstärke.

Irradiance generated on a detector.

²⁾ Entfernung zwischen Vorderseite Beinchen und Detektorebene.

Distance between leadframe front side and detection area.

Grenzwerte ($T_A = 25^\circ\text{C}$)**Maximum Ratings**

Bezeichnung Parameter	Symbol Symbol	Wert Value	Einheit Unit
Betriebs- und Lagertemperatur Operating and storage temperature range	$T_{\text{op}}; T_{\text{stg}}$	- 40 ... + 85	°C
Sperrspannung Reverse voltage	V_R	5	V
Durchlaßstrom Forward current	I_F (DC)	50	mA
Stoßstrom, $t_p = 10 \mu\text{s}, D = 0$ Surge current	I_{FSM}	1	A
Verlustleistung Power dissipation	P_{tot}	75	mW
Wärmewiderstand Sperrsicht - Umgebung Thermal resistance junction - ambient	R_{thJA}	450	K/W

Kennwerte ($T_A = 25^\circ\text{C}$)**Characteristics**

Bezeichnung Parameter	Symbol Symbol	Wert Value	Einheit Unit
Wellenlänge der Strahlung Wavelength at peak emission	λ_{peak}	950	nm
Spektrale Bandbreite bei 50% von I_{max} Spectral bandwidth at 50% of I_{max}	$\Delta\lambda$	55	nm
Abstrahlwinkel horizontal/ vertikal Half angle horizontal/ vertical	φ	$\pm 33/ 43$	Grad deg.
Aktive Chipfläche Active chip area	A	0.09	mm^2
Abmessungen der aktiven Chipfläche Dimensions of the active chip area	$L \times B$ $L \times W$	0.3×0.3	mm^2
Schaltzeiten, I_e von 10% auf 90% und von 90% auf 10%, bei $I_F = 50 \text{ mA}$, $R_L = 50 \Omega$ Switching times, I_e from 10% to 90% and from 90% to 10%, $I_F = 50 \text{ mA}$, $R_L = 50 \Omega$	t_r, t_f	0.5	μs
Kapazität, Capacitance $V_R = 0 \text{ V}, f = 1 \text{ MHz}$	C_o	40	pF

Kennwerte ($T_A = 25^\circ\text{C}$)**Characteristics (cont'd)**

Bezeichnung Parameter	Symbol Symbol	Wert Value	Einheit Unit
Durchlaßspannung, Forward voltage $I_F = 20 \text{ mA}, t_p = 20 \text{ ms}$	V_F	1.25 (≤ 1.6)	V
Sperrstrom, Reverse current $V_R = 5V$	I_R	0.01 (≤ 1.0)	μA
Gesamtstrahlungsfluß, Total radiant flux $I_F = 20 \text{ mA}, t_p = 20 \text{ ms}$	Φ_e	3.5	mW
Temperaturkoeffizient von I_e bzw. Φ_e , $I_F = 20 \text{ mA}$ Temperature coefficient of I_e or Φ_e , $I_F = 20 \text{ mA}$	TC_I	- 1.1	%/K
Temperaturkoeffizient von V_F , $I_F = 20 \text{ mA}$ Temperature coefficient of V_F , $I_F = 20 \text{ mA}$	TC_V	- 1.3	mV/K
Temperaturkoeffizient von λ , $I_F = 20 \text{ mA}$ Temperature coefficient of λ , $I_F = 20 \text{ mA}$	TC_λ	+ 0.3	nm/K

Bezeichnung Parameter	Symbol Symbol	Werte Values	Einheit Unit
Bestrahlungsstärke ¹⁾ Irradiance ¹⁾ $d^2 = 6\text{mm}, I_F = 4\text{mA}, t_p = 20 \text{ ms}$	E_e ¹⁾	0.25 ... 1.25	mW/cm^2

¹⁾ Auf einem Detektor erzeugte Bestrahlungsstärke.

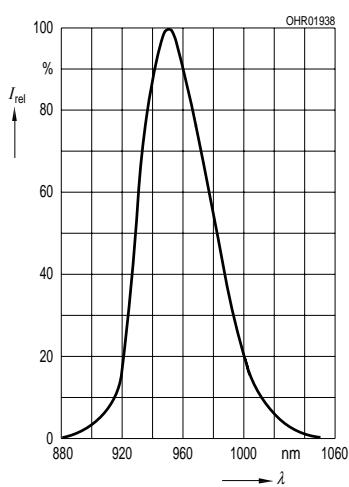
Irradiance generated on a detector.

²⁾ Entfernung zwischen Vorderseite Beinchen und Detektorebene.

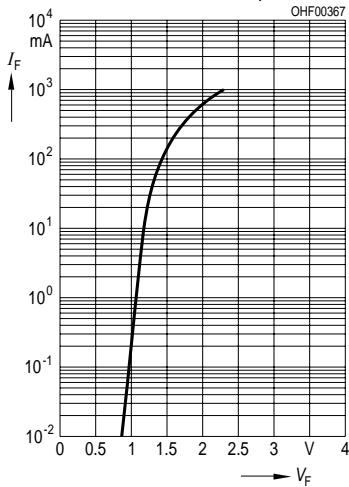
Distance between leadframe front side and detection area.

Relative Spectral Emission

$$I_{\text{rel}} = f(\lambda)$$

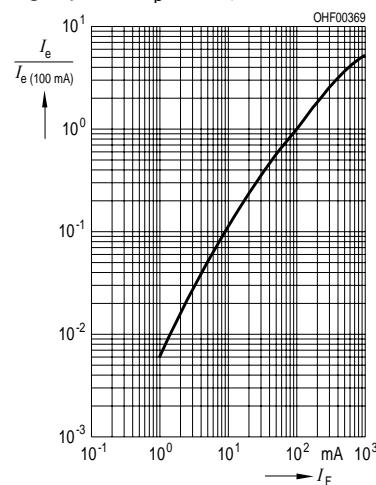
**Forward Current**

$$I_F = f(V_F), \text{ Single pulse, } t_p = 20 \mu\text{s}$$

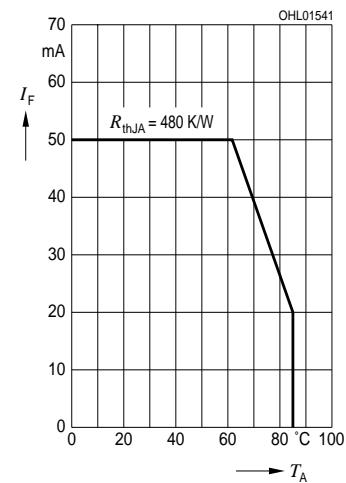


$$\frac{I_e}{I_e \text{ 100 mA}} = f(I_F)$$

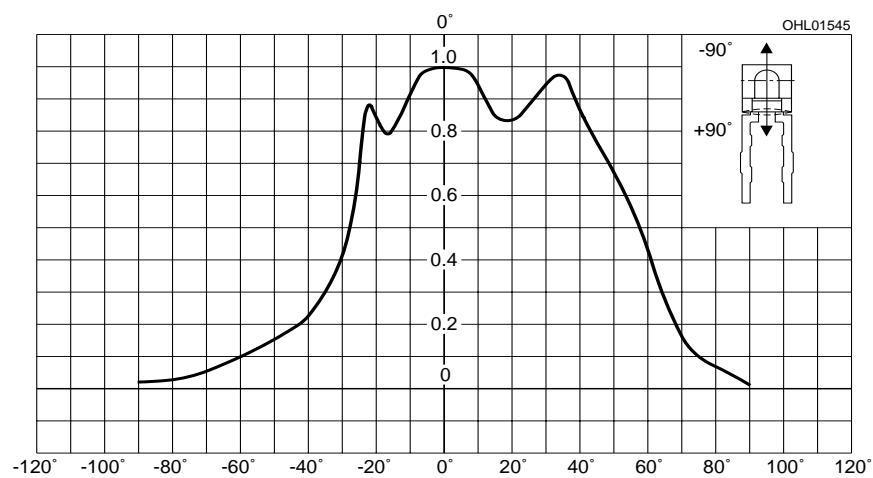
Single pulse, $t_p = 20 \mu\text{s}$

**Max. Permissible Forward Current**

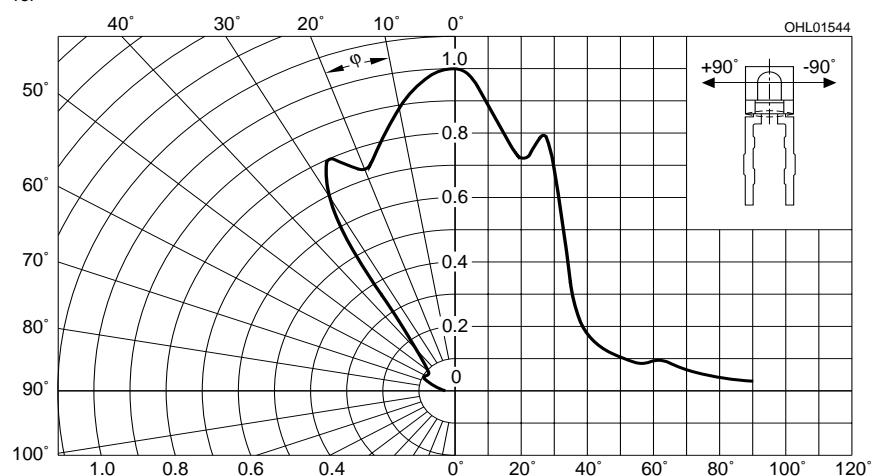
$$I_F = f(T_A)$$

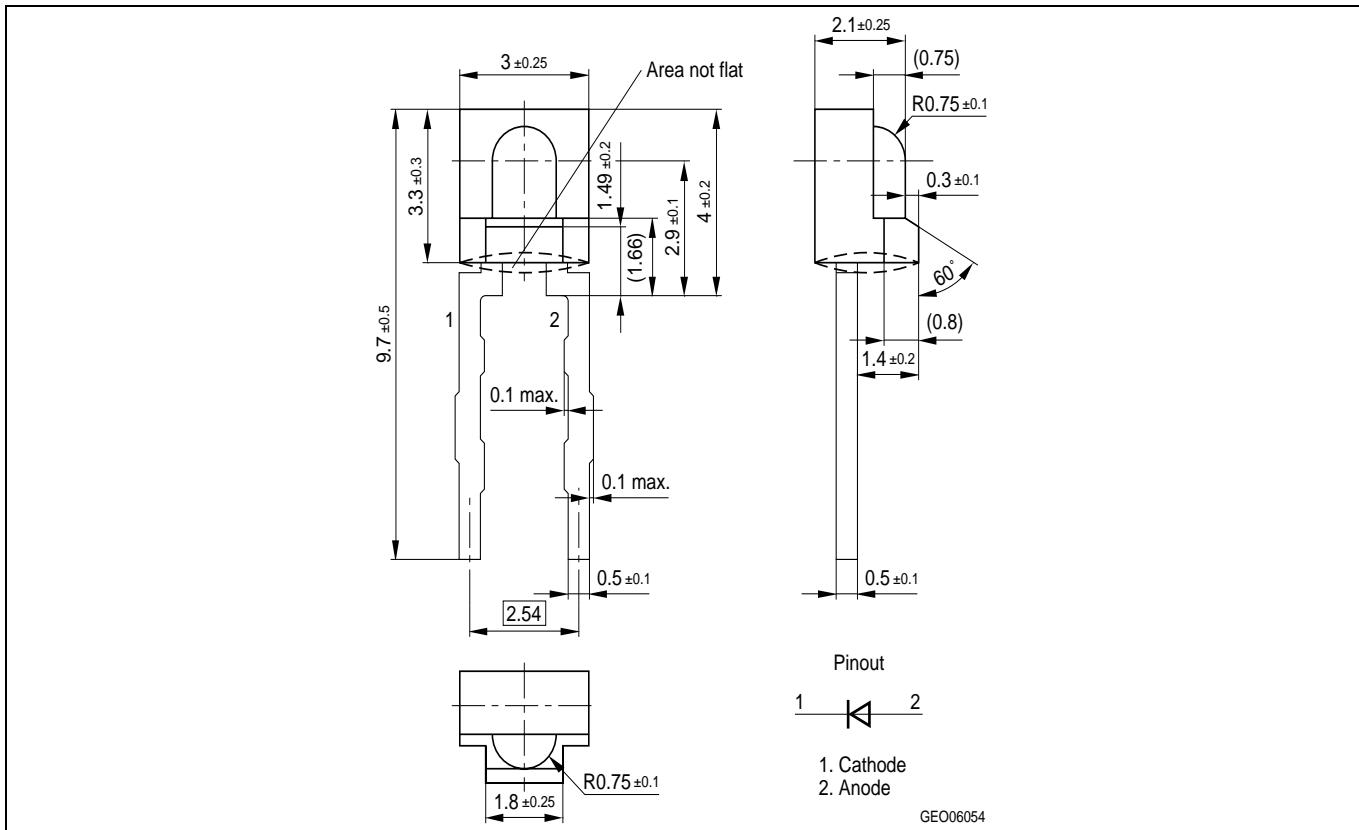
**Radiation Characteristics/ vertical**

$$I_{\text{rel}} = f(\phi)$$

**Radiation Characteristics/ horiz**

$$I_{\text{rel}} = f(\phi)$$



**Maßzeichnung
Package Outlines**

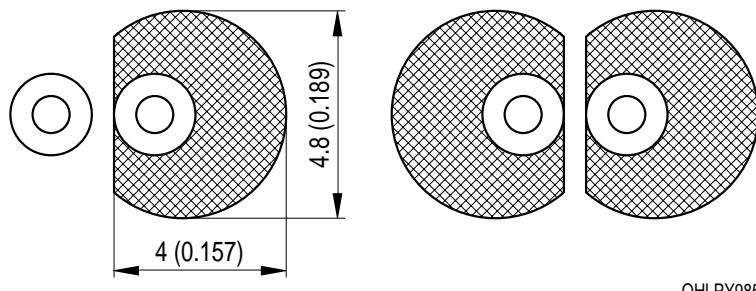
Maße in mm (inch) / Dimensions in mm (inch).

Empfohlenes Lötpaddesign

Recommended Solder Pad

Wellenlöten (TTW)

TTW Soldering

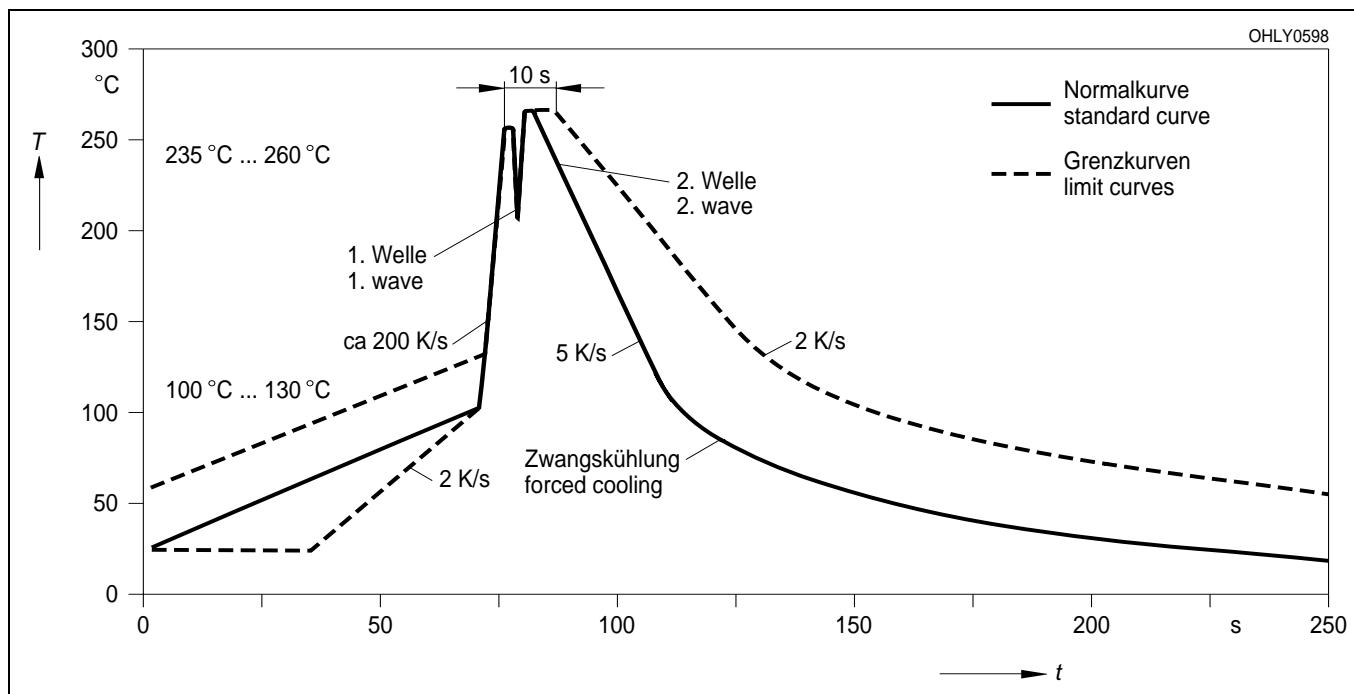


OHLPY985

Maße in mm (inch) / Dimensions in mm (inch).

Lötbedingungen
Soldering Conditions
Wellenlöten (TTW)
TTW Soldering

(nach CECC 00802)
 (acc. to CECC 00802)



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² Life support devices or systems are intended (a) to be implanted in the human body, or (b) to support and/or maintain and sustain human life. If they fail, it is reasonable to assume that the health of the user may be endangered.